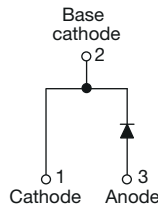


## High Voltage, Input Rectifier Diode, 10 A


**2L TO-220AC**


### FEATURES

- Very low forward voltage drop
- 150 °C max. operating junction temperature
- Glass passivated pellet chip junction
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**

### APPLICATIONS

- Input rectification
- Vishay Semiconductors switches and output rectifiers which are available in identical package outlines

### DESCRIPTION

High voltage rectifiers optimized for very low forward voltage drop with moderate leakage.

These devices are intended for use in main rectification (single or three phase bridge).

### PRIMARY CHARACTERISTICS

|                       |                 |
|-----------------------|-----------------|
| $I_{F(AV)}$           | 10 A            |
| $V_R$                 | 800 V to 1200 V |
| $V_F$ at $I_F$        | 1.1 V           |
| $I_{FSM}$             | 160 A           |
| $T_J$ max.            | 150 °C          |
| Package               | 2L TO-220AC     |
| Circuit configuration | Single          |

### OUTPUT CURRENT IN TYPICAL APPLICATIONS

| APPLICATIONS  | SINGLE-PHASE BRIDGE | THREE-PHASE BRIDGE | UNITS |
|---|---------------------|--------------------|-------|
| Capacitive input filter $T_A = 55$ °C, $T_J = 125$ °C common heatsink of 1 °C/W | 12.0                | 16.0               | A     |

### MAJOR RATINGS AND CHARACTERISTICS

| SYMBOL      | CHARACTERISTICS     | VALUES      | UNITS |
|-------------|---------------------|-------------|-------|
| $I_{F(AV)}$ | Sinusoidal waveform | 10          | A     |
| $V_{RRM}$   |                     | 800/1200    | V     |
| $I_{FSM}$   |                     | 160         | A     |
| $V_F$       | 10 A, $T_J = 25$ °C | 1.1         | V     |
| $T_J$       |                     | -40 to +150 | °C    |

### VOLTAGE RATINGS

| PART NUMBER   | $V_{RRM}$ , MAXIMUM PEAK REVERSE VOLTAGE<br>V | $V_{RSM}$ , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE<br>V | $I_{RRM}$<br>AT 150 °C<br>mA |
|---------------|---|--|------------------------------|
| VS-10ETS08-M3 | 800   | 900  | 0.5                          |
| VS-10ETS12-M3 | 1200  | 1300   |                              |

### ABSOLUTE MAXIMUM RATINGS

| PARAMETER   | SYMBOL        | TEST CONDITIONS                                | VALUES | UNITS             |
|---|---------------|--|--------|-------------------|
| Maximum average forward current                     | $I_{F(AV)}$   | $T_C = 105$ °C, 180° conduction half sine wave | 10     | A                 |
| Maximum peak one cycle non-repetitive surge current | $I_{FSM}$     | 10 ms sine pulse, rated $V_{RRM}$ applied      | 135    |                   |
|   |               | 10 ms sine pulse, no voltage reapplied         | 160    |                   |
| Maximum $I^2t$ for fusing                           | $I^2t$        | 10 ms sine pulse, rated $V_{RRM}$ applied      | 91     | A <sup>2</sup> s  |
|   |               | 10 ms sine pulse, no voltage reapplied         | 130    |                   |
| Maximum $I^2\sqrt{t}$ for fusing                    | $I^2\sqrt{t}$ | $t = 0.1$ ms to 10 ms, no voltage reapplied    | 1300   | A <sup>2</sup> √s |



| ELECTRICAL SPECIFICATIONS       |             |  |                               |        |                  |
|---------------------------------|-------------|--|-------------------------------|--------|------------------|
| PARAMETER                       | SYMBOL      | TEST CONDITIONS                        |                               | VALUES | UNITS            |
| Maximum forward voltage drop    | $V_{FM}$    | 10 A, $T_J = 25\text{ }^\circ\text{C}$ |                               | 1.1    | V                |
| Forward slope resistance        | $r_t$       | $T_J = 150\text{ }^\circ\text{C}$      |                               | 20     | $\text{m}\Omega$ |
| Threshold voltage               | $V_{F(TO)}$ |  |                               | 0.82   | V                |
| Maximum reverse leakage current | $I_{RM}$    | $T_J = 25\text{ }^\circ\text{C}$       | $V_R = \text{Rated } V_{RRM}$ | 0.05   | mA               |
|                                 |             | $T_J = 150\text{ }^\circ\text{C}$      |                               | 0.50   |                  |

| THERMAL - MECHANICAL SPECIFICATIONS                         |                |                        |  |             |                           |
|---|----------------|------------------------|--|-------------|---------------------------|
| PARAMETER   | SYMBOL         | TEST CONDITIONS        |  | VALUES      | UNITS                     |
| Maximum junction and storage temperature range              | $T_J, T_{Stg}$ |                        |  | -40 to +150 | $^\circ\text{C}$          |
| Maximum thermal resistance, junction to case                | $R_{thJC}$     | DC operation           |  | 2.5         | $^\circ\text{C}/\text{W}$ |
| Maximum thermal resistance, junction to ambient (PCB mount) | $R_{thJA}$     |                        |  | 62          |                           |
| Soldering temperature                                       | $T_S$          |                        |  | 240         | $^\circ\text{C}$          |
| Approximate weight  |                |                        |  | 2           | g                         |
|   |                |                        |  | 0.07        | oz.                       |
| Marking device  |                | Case style 2L TO-220AC |  | 10ETS08     |                           |
|   |                |                        |  | 10ETS12     |                           |

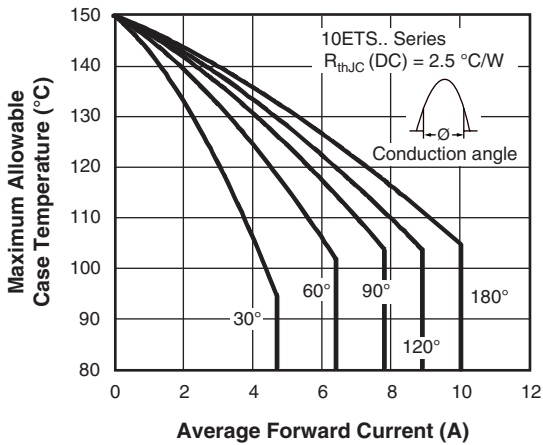


Fig. 1 - Current Rating Characteristics

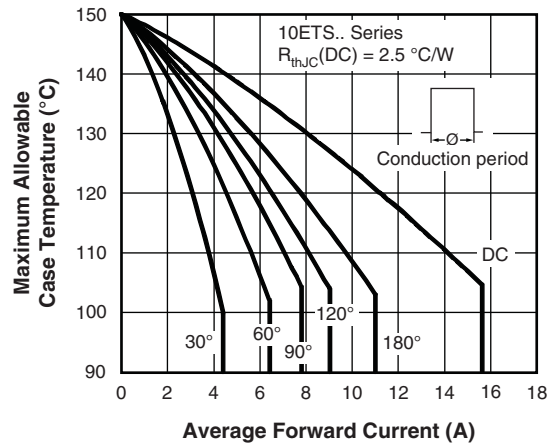


Fig. 2 - Current Rating Characteristics

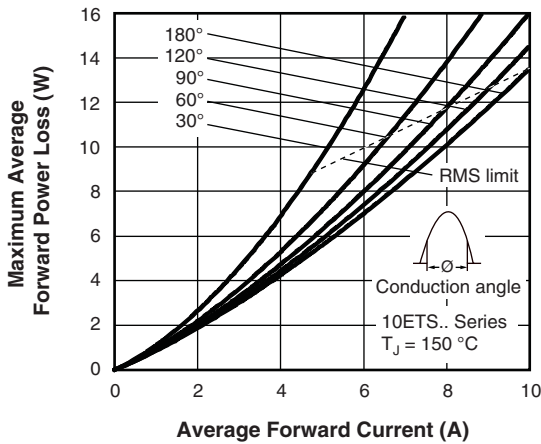


Fig. 3 - Forward Power Loss Characteristics

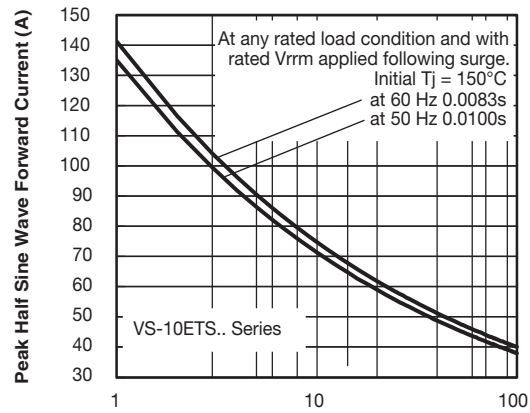


Fig. 5 - Maximum Non-Repetitive Surge Current

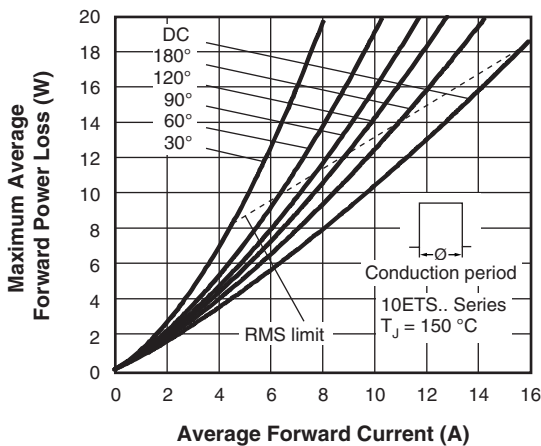


Fig. 4 - Forward Power Loss Characteristics

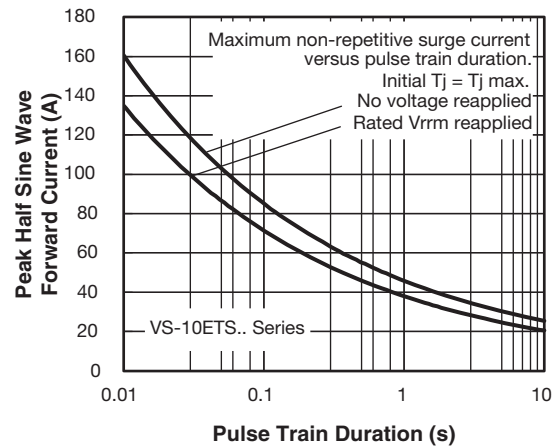


Fig. 6 - Maximum Non-Repetitive Surge Current

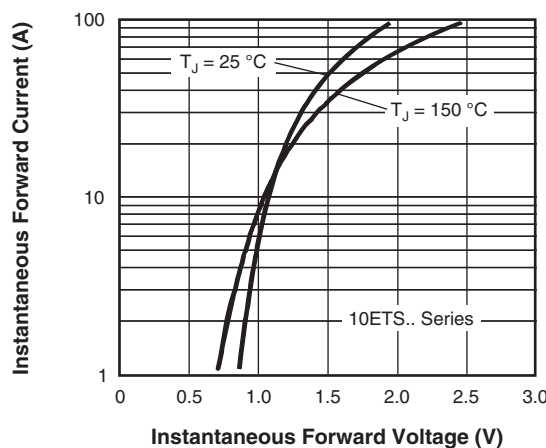


Fig. 7 - Forward Voltage Drop Characteristics

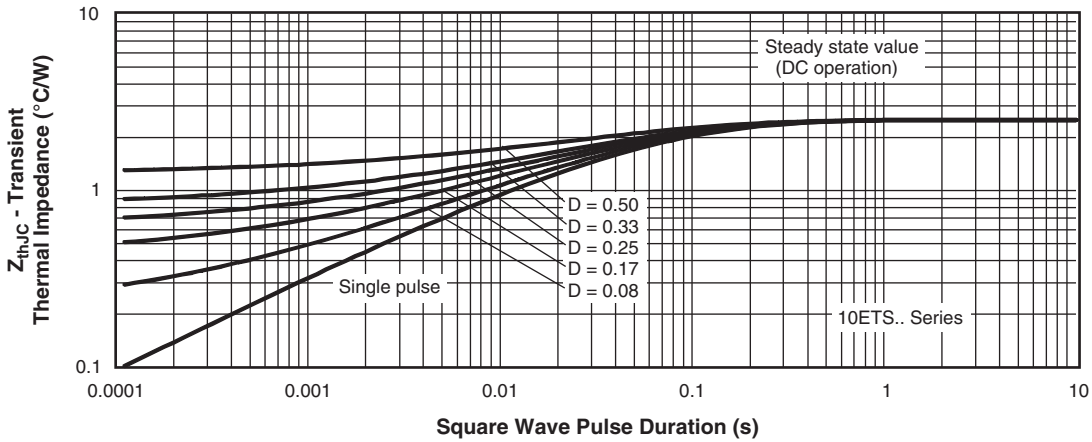


Fig. 8 - Thermal Impedance  $Z_{thJC}$  Characteristics

**ORDERING INFORMATION TABLE**

|             |            |           |          |          |          |           |            |
|-------------|------------|-----------|----------|----------|----------|-----------|------------|
| Device code | <b>VS-</b> | <b>10</b> | <b>E</b> | <b>T</b> | <b>S</b> | <b>12</b> | <b>-M3</b> |
|             | ①          | ②         | ③        | ④        | ⑤        | ⑥         | ⑦          |

- 1** - Vishay Semiconductors product
- 2** - Current rating (10 = 10 A)
- 3** - Circuit configuration:  
E = single
- 4** - Package:  
T = 2L TO-220AC
- 5** - Type of silicon:  
S = standard recovery rectifier
- 6** - Voltage code x 100 =  $V_{RRM}$ 

|             |
|-------------|
| 08 = 800 V  |
| 12 = 1200 V |
- 7** - Environmental digit:  
-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

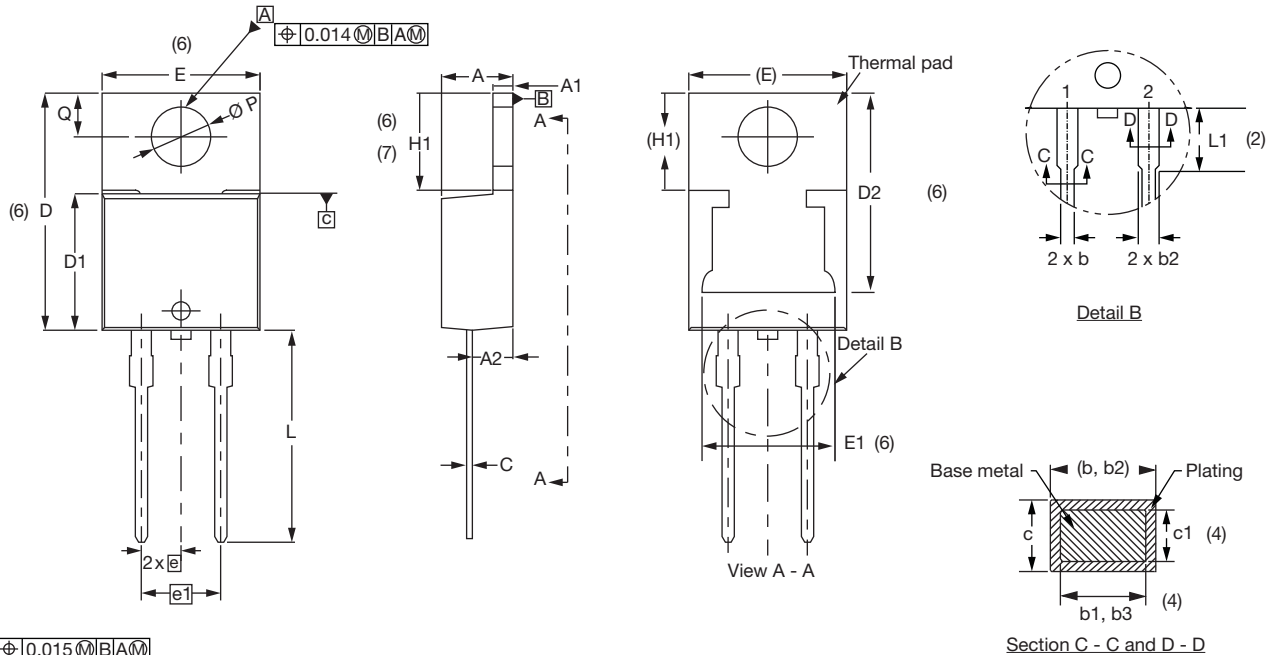
| <b>ORDERING INFORMATION (Example)</b> |                  |                        |                          |
|---------------------------------------|------------------|------------------------|--------------------------|
| PREFERRED P/N                         | QUANTITY PER T/R | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION    |
| VS-10ETS08-M3                         | 50               | 1000                   | Antistatic plastic tubes |
| VS-10ETS12-M3                         | 50               | 1000                   | Antistatic plastic tubes |

| <b>LINKS TO RELATED DOCUMENTS</b> |  |
|-----------------------------------|--|
| Dimensions                        | <a href="http://www.vishay.com/doc?96156">www.vishay.com/doc?96156</a> |
| Part marking information          | <a href="http://www.vishay.com/doc?95391">www.vishay.com/doc?95391</a> |



# 2L TO-220AC

**DIMENSIONS** in millimeters and inches



Conforms to JEDEC® outline TO-220AC

| SYMBOL | MILLIMETERS |       | INCHES |       | NOTES | SYMBOL | MILLIMETERS |       | INCHES |       | NOTES |
|--------|-------------|-------|--------|-------|-------|--------|-------------|-------|--------|-------|-------|
|        | MIN.        | MAX.  | MIN.   | MAX.  |       |        | MIN.        | MAX.  | MIN.   | MAX.  |       |
| A      | 4.25        | 4.65  | 0.167  | 0.183 |       | D2     | 11.68       | 12.88 | 0.460  | 0.507 | 6     |
| A1     | 1.14        | 1.40  | 0.045  | 0.055 |       | E      | 10.11       | 10.51 | 0.398  | 0.414 | 3, 6  |
| A2     | 2.50        | 2.92  | 0.098  | 0.115 |       | E1     | 6.86        | 8.89  | 0.270  | 0.350 | 6     |
| b      | 0.69        | 1.01  | 0.027  | 0.040 |       | e      | 2.41        | 2.67  | 0.095  | 0.105 |       |
| b1     | 0.38        | 0.97  | 0.015  | 0.038 | 4     | e1     | 4.88        | 5.28  | 0.192  | 0.208 |       |
| b2     | 1.20        | 1.73  | 0.047  | 0.068 |       | H1     | 6.09        | 6.48  | 0.240  | 0.255 | 6, 7  |
| b3     | 1.14        | 1.73  | 0.045  | 0.068 | 4     | L      | 13.52       | 14.02 | 0.532  | 0.552 |       |
| c      | 0.36        | 0.61  | 0.014  | 0.024 |       | L1     | 3.32        | 3.82  | 0.131  | 0.150 | 2     |
| c1     | 0.36        | 0.56  | 0.014  | 0.022 | 4     | ∅ P    | 3.54        | 3.91  | 0.139  | 0.154 |       |
| D      | 14.85       | 15.35 | 0.585  | 0.604 | 3     | Q      | 2.60        | 3.00  | 0.102  | 0.118 |       |
| D1     | 8.38        | 9.02  | 0.330  | 0.355 |       |        |             |       |        |       |       |

**Notes**

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3, and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2, and E1
- (7) Outline conforms to JEDEC® TO-220, except D2 (minimum)



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